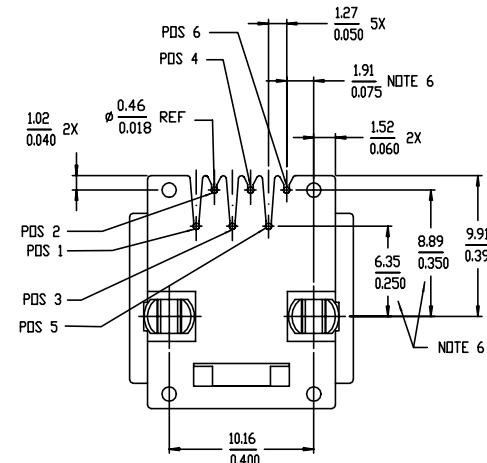
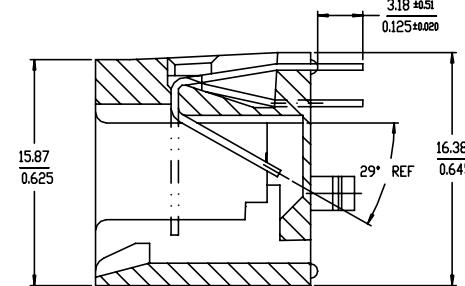
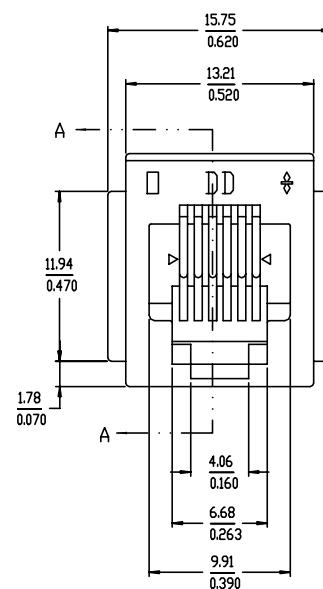
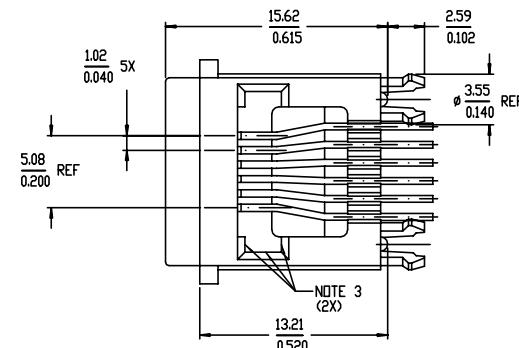


PRODUCT NO.

SEE CHART



SECTION A-A

mat'l. code			surface	tolerance	projection	product family
ltr	ecn	nodr	date	ISD1302 ✓	ISD1101 ISD406	title
N	ND4-0102	YS	11/23/04	tolerances unless otherwise specified		MOD JACK
P	N08-0097	SH	09/25/08	angle	0.X±0.3	
R	N08-0170	SH	10/10/08	0°±2°	0.XXX±0.05	scale 2.0
S	ELX-N-010713SH	MA0	3/14/12	dir	M CHENG	6 POS VERT. SNAP PEG
				engr	M CHENG	PCB III MOD JACK ASSY
				chr	M CHENG	
				appd	J HSIA	
sheet	revisions	S				
index	sheet	1 2				

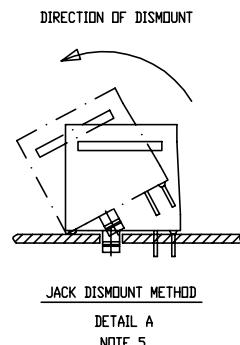
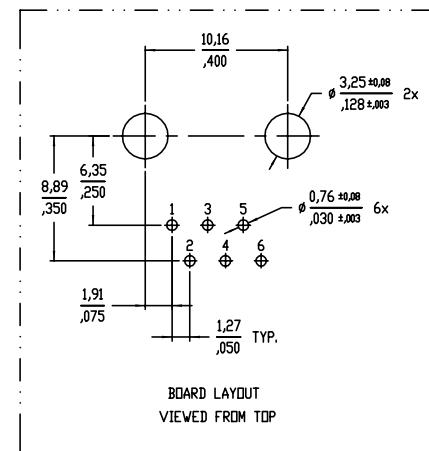
dwg no sheet 1 of 2 size
90512 A4
type Product Customer Drawing

FCI

PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	NOTES
90512-001 -001LF -011LF	ALL	5u" Au + high performance lubricant	BLACK
-002 -002LF -012LF	ALL	5u" Au + high performance lubricant	BLACK
-003 -003LF -013LF	2,3,4,5	5u" Au + high performance lubricant	BLACK
-004 -004LF -014LF	2,3,4,5	50u" / 1.27u GXT	BLACK
-005 -005LF -015LF	3,4	5u" Au + high performance lubricant	BLACK
-006 -006LF	ALL	5u" Au + high performance lubricant	GREY
-007 -007LF	ALL	5u" Au + high performance lubricant	GREY
-008 -008LF	3,4	5u" Au + high performance lubricant	GREY

(11)

(11)



PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	REMARKS
90512-101 -101LF -111LF	ALL	5u" Au + high performance lubricant	NOT TOOLED
-102 -102LF -112LF	ALL	5u" Au + high performance lubricant	NOT TOOLED
-103 -103LF -113LF	2,3,4,5	5u" Au + high performance lubricant	NOT TOOLED
-104 -104LF -114LF	2,3,4,5	50u" / 1.27u GXT	NOT TOOLED
-105 -105LF -115LF	3,4	5u" Au + high performance lubricant	NOT TOOLED

(11)

LEAD FREE PRODUCT NO.

0: MEETS WAVE SOLDER PROCESS PRODUCT NO.

1: MEETS PIP PROCESS PRODUCT NO.

NOTES :

- 1 P/N/D WITH DASH 0XX -NORMAL WAVE SOLDERING APPLICATION.
P/N/D WITH DASH 1XX -IR REFLOW APPLICATION (NOT TOOLED).
- 2 PACKAGING SPEC. BUS-14-164.
- 3 SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- 4 JACK IS FOR 1.57/.062 THICK PCB.
- 5 SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB, PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- 6 THESE DIMENSIONS ARE TAKEN FROM THE TOP OF THE PEG.
- 7 THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 8 THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- 9 IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.
- 10 EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTODMR .

mat'l. code			surface	tolerance	projection	product family
ltr	ecn	nodr	ISD1302 ✓	ISD1101 ISD406	wise specified	MOD JACK
N	N04-0102	YS	11/23/04	angle 0.0 ± 0.3	mm	6 POS VERT. SNAP PEG
P	N08-0097	SH	09/25/08	angle 0.0X ± 0.15	scale 2.0	PCB III MOD JACK ASSY
R	N08-0170	SH	10/10/08	0° ± 2°		
S	ELX-N-010713H MWD	3/14/12	dr	M CHENG	7/13/01	dwg no
			engr	M CHENG	7/13/01	sheet 2 of 2
			chr	M CHENG	7/18/01	size
			appd	J HSIA	7/20/01	A4
			sheet			
			revision			
			index			
			sheet			

FCI